

HVL375B

Variable Capacitance Diode for VCO

RENESAS

ADE-208-1565 (Z)

Rev.0
Dec. 2002

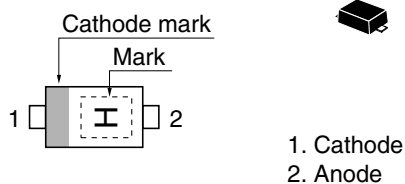
Features

- Low tolerance.
- Low series resistance. ($r_s = 1.1 \Omega$ max)
- Good C-V linearity.
- Extremely small Flat Package (EFP) is suitable for surface mount design.

Ordering Information

Type No.	Laser Mark	Package Code
HVL375B	H	EFP

Pin Arrangement



Absolute Maximum Ratings

(Ta = 25°C)

Item	Symbol	Value	Unit
Reverse voltage	V_R	10	V
Junction temperature	Tj	125	°C
Storage temperature	Tstg	-55 to +125	°C

Electrical Characteristics

(Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse current	I_{R1}	—	—	10	nA	$V_R = 10\text{ V}$
	I_{R2}	—	—	100		$V_R = 10\text{ V}, T_a = 60^\circ\text{C}$
Capacitance	C_1	15.0	—	16.5	pF	$V_R = 1\text{ V}, f = 1\text{ MHz}$
	C_3	5.0	—	6.0		$V_R = 3\text{ V}, f = 1\text{ MHz}$
	C_4	3.3	—	4.0		$V_R = 4\text{ V}, f = 1\text{ MHz}$
Capacitance ratio	n	4.0	—	—	—	C_1 / C_4
Series resistance	r_s	—	—	1.1	Ω	$V_R = 2\text{ V}, f = 470\text{ MHz}$

Notes: 1. Please do not use the soldering iron due to avoid high stress to the EFP package.

2. The material of lead is exposed for cutting plane. Therefore, soldering nature of lead tip part is considered as unquestioned. Please kindly consider soldering nature.

Main Characteristic

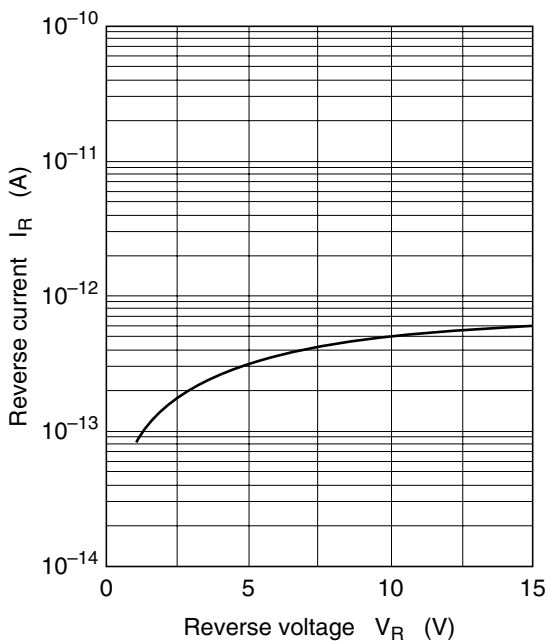


Fig.1 Reverse current vs. Reverse voltage

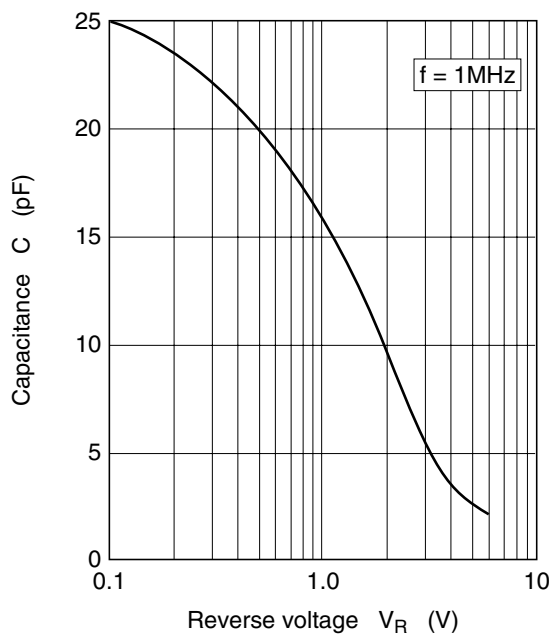


Fig.2 Capacitance vs. Reverse voltage

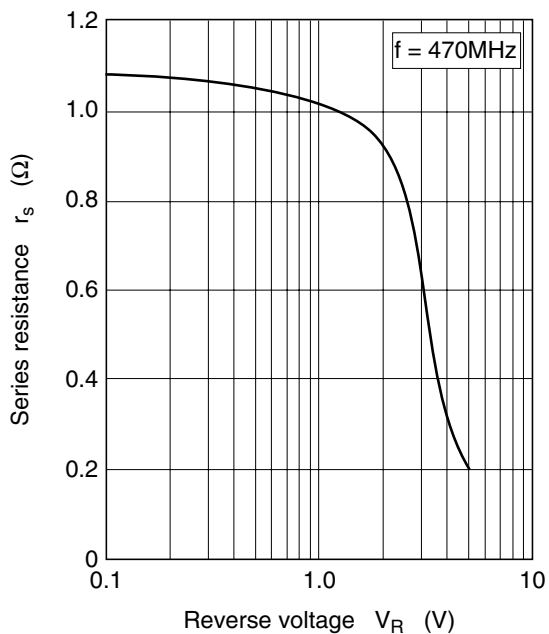


Fig.3 Series resistance vs. Reverse voltage

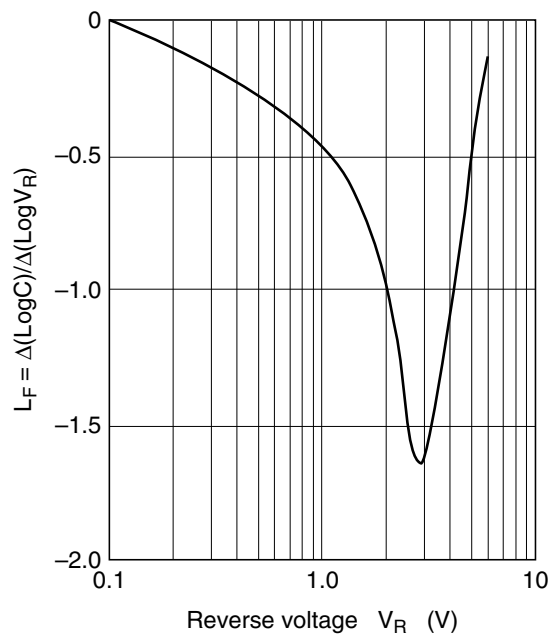
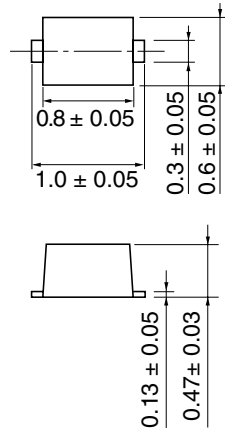


Fig.4 L_F vs. Reverse voltage

Package Dimensions

As of July, 2002

Unit: mm



Hitachi Code	EFP
JEDEC	—
JEITA	—
Mass (reference value)	0.0007 g

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